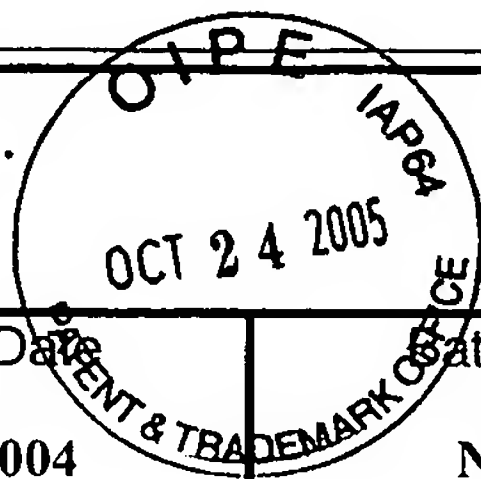


IFW

TRANSMITTAL OF FORMAL DRAWINGS

Docket No.
FIS920040069US1

In Re Application Of: Bedell et al.



Serial No.

10/710,826

Filing Date

08/05/2004

Batch No.

N/A

Examiner

not yet assigned

Art Unit

2812

Invention: **METHOD OF FORMING STRAINED SILICON MATERIALS WITH IMPROVED THERMAL CONDUCTIVITY**

Address to:
Assistant Commissioner for Patents
Washington, D.C. 20231

Transmitted herewith are:

2 sheets of formal drawing(s) for this application.


Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c) on the reverse side of the drawing.


Signature

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Dated: October 19, 2005

I certify that this document and attached formal drawings are being deposited on October 19, 2005 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.



Signature of Person Mailing Correspondence

Robert Faber

Typed or Printed Name of Person Mailing Correspondence